MICHAEL T GERVASONI

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Summary

Full-stack Developer with an Engineering background. Interested in all things software engineering. Passionate about solving complex problems to better our world.

Engineering Experience

Junior Software Developer, The 5th Ingredient, LLC

June 2018 – Present

- Responsible for developing full stack SaaS modules for big data software
- Gained Proficiency in programming with Apache, MySQL, PHP
- Designed user interface with HTML5 and CSS3
- Created functionality with JavaScript (ES6)
- Applied Dev Ops and deploying with AWS
- Designed cron functions for email and text notifications using AWS Simple Email Server and Twilio.

Full-Stack Web Developer, Learn Academy

March 2018 - June 2018

- Created several full stack web applications using React, PostgreSQL, Rails
- Developed RESTful APIs and integrated applications
 with external APIs
- Applied Pair programming, SCRUM methodology, and test driven development using RSpec, Cabybara, and Enzyme.
- Built and deployed a full stack React with Rails fitness tracking application: https://fitology-app.herokuapp.com

Development Engineer, HRL Laboratories, LLC

May 2016 - August 2017

- Led project to develop material from conception to actualization
- Enhanced program by doubling material strength and tripling material durability
- Developed detailed synthesis, processing techniques, and testing procedures
- Met over two dozen deliverables, delivered presentations and authored a patent

Skills

Languages - JavaScript, PHP, Ruby, Python, C Frameworks - React, Rails, Express, Codelgniter Frontend - HTML5, CSS3 Backend – MySQL, Postgres, Node.js Tools - Git, Linux, LabVIEW, Regex, Command Line, RSpec, Cabybara, Enzyme, MATLAB, R

Education

B.S. Materials Engineering

UCLA March 2017 Summa cum laude (3.96/4 GPA)

Full-Stack Web Dev Program

Learn Academy June 2018

A.A.S Marketing

Achievements

Patent January 29, 2018 *Composite Materials, and Systems and Methods for Making Composite Materials*

Publication October 2016

PRIME 2016/230th ECS Meeting Decreased Surface Porosity and Roughness of InP for Epitaxy: A Path to Integration of High Performance Electronics.

Competition Winner 2016

1st Place: PRiME Poster Competition 2nd Place: RiseUP Research Competition

Scholarships 2015 - 2018 Blue and Gold, Shirley and Walter Wang, University Grant, MUSE Scholar